



Product Change Notification

Change Notification #: **116722 - 00**

Change Title: **Select Intel® SSD DC P4510 Series SKUs,
PCN 116722-00, Documentation,
Add China RoHS flyer to outer shipping
box**

Date of Publication: **January 22, 2019**

Key Characteristics of the Change:

Documentation

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 6, 2019
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Description of Change to the Customer:

The Intel® SSD DC P4510 Series SKUs listed in the Products Affected Table below will have the following change.

A China ROHS flyer will be added to the outer shipping box. See pictures below.

Pre-Change



Post Change



Customer Impact of Change and Recommended Action:

There is no change to the Form, Fit, or Function of the product. The change is the addition of flyer to the packaging.

Customers should be aware of the change and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	TA
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX010T810	959392	J65288-103
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX020T810	959394	J65292-004
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX040T810	959396	J65290-101
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX080T810	959398	J65294-002

PCN Revision History:

Date of Revision:

January 22, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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